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## ClockMatrix

### EEPROM Programming Instructions

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#### Introduction

The 8A3xxxx Family of products from IDT are designed to power-up and operate using internal resources. However there may be cases where it is necessary or convenient to make use of an external I2C serial EEPROM for the device to obtain alternate information from at reset.

This document provides information about the EEPROM hardware connections, how to program the EEPROM using the Clock Matrix chip, and other miscellaneous information.

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## 1. EEPROM Overview

The ClockMatrix 8A3xxxx product family from Renesas is designed to power-up and operate using internal resources. However, there may be cases where it is necessary or convenient to use an external I2C serial EEPROM for the device in order to obtain alternate information at reset.

The external EEPROM can be used to contain one or more of the following:

- Device configuration information block (Config)
- Micro-controller Firmware Full Application Load (FW Application)
- Micro-controller Firmware Patch (FW Hotfix)

These blocks may appear in any order in the EEPROM, but only one FW Application or one FW Hotfix will be applied. A FW Hotfix may not be applied to a FW Application block loaded from EEPROM; only to the internal (embedded) firmware. Any number of Config blocks are allowed.

Renesas will provide the EEPROM image in the form of a .hex file that is formatted according to the Intel Hex format. Details of the structure of the EEPROM is beyond the scope of this document.

The following instructions describe the hardware connections for the EEPROM, how to program the EEPROM using the Clock Matrix chip, and other miscellaneous information.

## 2. Hardware Setup

The following is an example setup schematic.

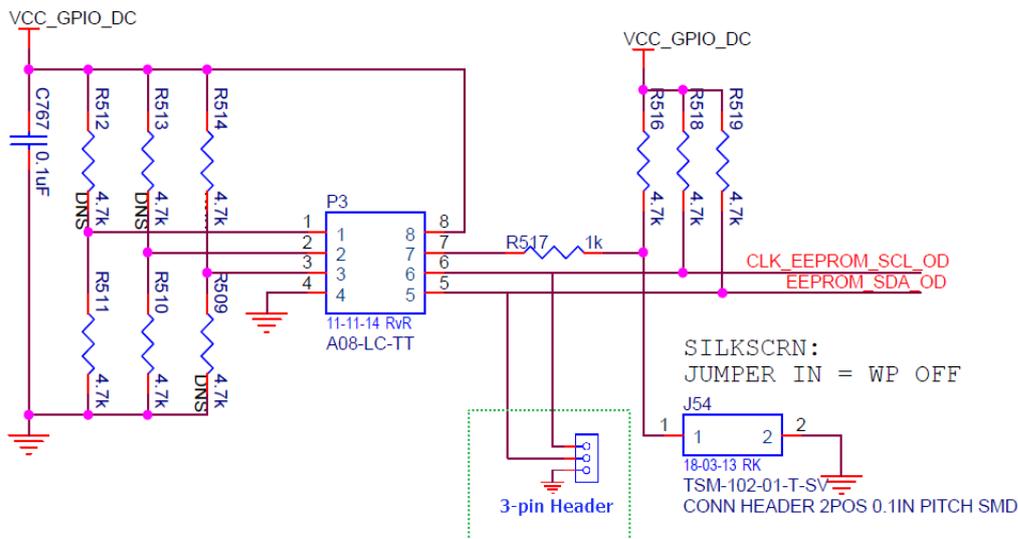


Figure 1. EEPROM Circuit

Connect the SCLK and SDA traces to the ClockMatrix device master I2C port (SCLK and SDA). Another recommendation is to also place a 3-pin header that connects to the EEPROM SCLK, SDA, and GND pin (see green outline in [Figure 1](#)). Using this method, an external programmer can be connected to the system for programming. Be aware that external programmers may only support 3.3V levels, so if the VCC\_GPIO on the chip is 1.8V or 2.5V a level translator is required.

In the case of prototype boards, a PDIP socket, such as the DILV8P-223TLF can be used (see [Figure 2](#)). This allows for easy removal of the EEPROM so that it can be programmed using an external board, such as the Total Phase EEPROM Socket Board.



Figure 2. PDIP Socket

### 3. Programming the EEPROM

There are three options for programming the EEPROM:

- External EEPROM flash card
- Header
- Clock Matrix chip

#### 3.1 External Flash Card Option

For this option, use the PDIP socket. Use the Total Phase EEPROM socket board to program the EEPROM and then place the EEPROM into the socket. For more information, see *Programming the 8A3x000 EEPROM with Total Phase*. Alternatively, another vendor's EEPROM flash card can be used.

#### 3.2 Header Option

For this option, the EEPROM is installed in the system board and an accompanying 3-pin header is used as described in *Programming the 8A3x000 EEPROM with Total Phase*. However, connect the Total Phase Aardvark card directly to the 3-pin header and use the Total Phase software to program the EEPROM.

#### 3.3 Clock Matrix Option

For this option, the ClockMatrix chip serves as the intermediary, transferring the data from the System Device to the EEPROM, as shown in [Figure 3](#). Either a CPU, an FPGA, or a different System device will “talk” to the ClockMatrix device through the Main or Auxiliary Serial port and send it the firmware data. In turn, the ClockMatrix device will send the data to the EEPROM chip. Note that it is the customer's responsibility to parse the .hex file into a format that is usable by their system.



Figure 3. Programming the EEPROM through Clock Matrix

The ClockMatrix device contains a register buffer that functions as an EEPROM read/write buffer. Access to the buffer is obtained using the following registers. For register offset values, see the *8A3xxxx Family Programming Guide* that corresponds to the firmware present in the ROM.

**Module: EEPROM**

Access EEPROM.

**Table 369: EEPROM Register Index**

Offset (Hex)	Register Module Base Address: CF68h	
	Individual Register Name	Register Description
000h	EEPROM.EEPROM_I2C_ADDR	EEPROM I2C address.
001h	EEPROM.EEPROM_SIZE	EEPROM data transfer size.
002h	EEPROM.EEPROM_OFFSET	EEPROM offset.
004h	EEPROM.EEPROM_CMD	EEPROM command.

**EEPROM.EEPROM\_SIZE**

Configure the number of bytes to read or write.

**Table 371: EEPROM.EEPROM\_SIZE Bit Field Locations and Descriptions**

Offset Address (Hex)	EEPROM.EEPROM_SIZE Bit Field Locations							
	D7	D6	D5	D4	D3	D2	D1	D0
001h	BYTES[7:0]							

EEPROM.EEPROM_SIZE Bit Field Descriptions			
Bit Field Name	Field Type	Default Value	Description
BYTES[7:0]	R/W	0	Number of bytes to read or write. These bytes are transferred through OTP_EEPROM_BUFF. Valid range is 0 to 128.

**EEPROM.EEPROM\_I2C\_ADDR**

EEPROM I2C address.

**Table 370: EEPROM.EEPROM\_I2C\_ADDR Bit Field Locations and Descriptions**

Offset Address (Hex)	EEPROM.EEPROM_I2C_ADDR Bit Field Locations							
	D7	D6	D5	D4	D3	D2	D1	D0
000h	RESERVED	I2C_ADDR[6:0]						

EEPROM.EEPROM_I2C_ADDR Bit Field Descriptions			
Bit Field Name	Field Type	Default Value	Description
RESERVED	N/A	-	This field must not be modified from the read value
I2C_ADDR[6:0]	R/W	0	I2C address of the EEPROM.

**EEPROM.EEPROM\_OFFSET**

**Table 365: EEPROM.EEPROM\_OFFSET Bit Field Locations and Descriptions**

Offset Address (Hex)	EEPROM.EEPROM_OFFSET Bit Field Locations							
	D7	D6	D5	D4	D3	D2	D1	D0
002h	EEPROM_OFFSET[7:0]							
003h	EEPROM_OFFSET[15:8]							

EEPROM.EEPROM_OFFSET Bit Field Descriptions			
Bit Field Name	Field Type	Default Value	Description
EEPROM_OFFSET[15:0]	R/W	0	-

**EEPROM.EEPROM\_CMD**

**Table 366: EEPROM.EEPROM\_CMD Bit Field Locations and Descriptions**

Offset Address (Hex)	EEPROM.EEPROM_CMD Bit Field Locations							
	D7	D6	D5	D4	D3	D2	D1	D0
004h	EEPROM_CMD[7:0]							
005h	EEPROM_CMD[15:8]							

EEPROM.EEPROM_CMD Bit Field Descriptions			
Bit Field Name	Field Type	Default Value	Description
EEPROM_CMD[15:0]	R/W	0	- EE01 = Read from EEPROM EE02 = Write to EEPROM EE03 = Write (no verify)

**GENERAL\_STATUS.EEPROM\_STATUS**

**Table 11: GENERAL\_STATUS.EEPROM\_STATUS Bit Field Locations and Descriptions**

Offset Address (Hex)	GENERAL_STATUS.EEPROM_STATUS Bit Field Locations							
	D7	D6	D5	D4	D3	D2	D1	D0
008h	EEPROM_STATUS[7:0]							
009h	EEPROM_STATUS[15:8]							

GENERAL_STATUS.EEPROM_STATUS Bit Field Descriptions			
Bit Field Name	Field Type	Default Value	Description
EEPROM_STATUS[15:0]	R/O	0	Current status of EEPROM. 0x0000 = no status 0x8000 = ok 0x8001 = unknown command 0x8002 = wrong size 0x8003 = out of range 0x8004 = read failed 0x8005 = write failed 0x8006 = verification failed



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## 4. Revision History

Rev.	Date	Description
1.00	Feb.10.2020	Initial release.

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